

# 0.8A, 600V - 1000V Standard Bridge Rectifier

#### **FEATURES**

- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

### **MECHANICAL DATA**

- Case: TO-269AA (MBS)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.120g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	0.8	Α	
$V_{RRM}$	600 - 1000	V	
I <sub>FSM</sub>	35 A		
$T_{JMAX}$	150	°C	
Package	TO-269AA (MBS)		
Configuration	Quad		

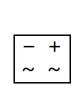


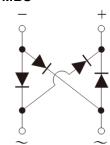






#### **MBS**





ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		SYMBOL	MBS6-K	MBS8-K	MBS10-K	UNIT
Marking code on the device			MBS6	MBS8	MBS10	
Repetitive peak rev	Repetitive peak reverse voltage		600	800	1000	V
Reverse voltage, to	Reverse voltage, total rms value		420	560	700	V
Forward current	On glass-epoxy	l <sub>F</sub>	0.5		Α	
	On aluminum substrate		0.8		Α	
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load		I <sub>FSM</sub>	35		А	
Rating for fusing (t<8.3ms)		l <sup>2</sup> t	5.08		A <sup>2</sup> s	
Junction temperature		TJ	- 55 to +150		°C	
Storage temperature		T <sub>STG</sub>	- 55 to +150			°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	20	°C/W
Junction-to-ambient thermal resistance	R <sub>OJA</sub>	85	°C/W

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>	I <sub>F</sub> = 0.4A,T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1	V
Deverse surrent @ reted // ner diade(2)	T <sub>J</sub> = 25°C	I <sub>R</sub>	-	5	μΑ
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 125°C		-	100	μΑ

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING	
MBSx-K	TO-269AA (MBS)	3,000 / Tape & Reel	

#### Notes:

1. "x" defines voltage from 600V(MBS6-K) to 1000V(MBS10-K)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

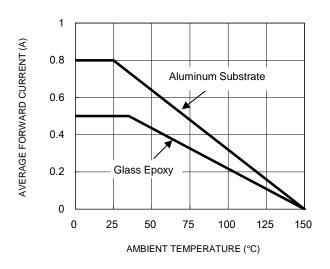
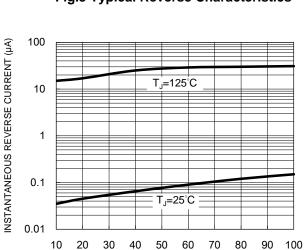


Fig.3 Typical Reverse Characteristics



PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

**Fig.2 Typical Junction Capacitance** 

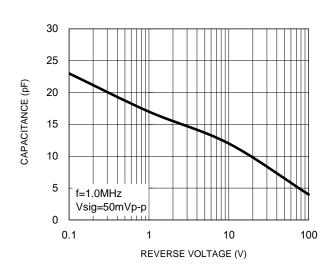


Fig.4 Typical Forward Characteristics

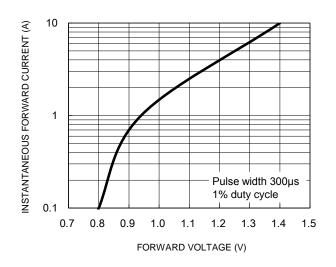
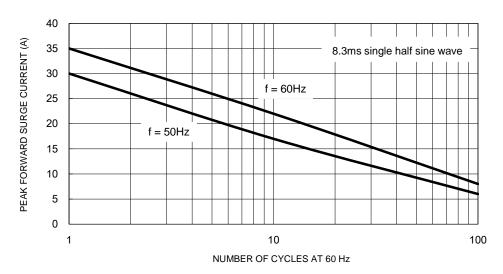
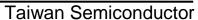


Fig.5 Maximum Non-Repetitive Forward Surge Current

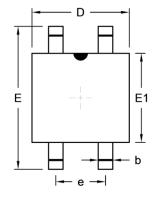


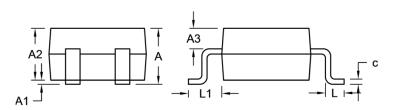




### **PACKAGE OUTLINE DIMENSIONS**

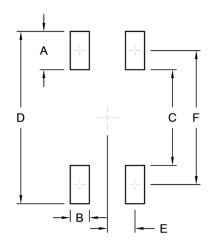
### **TO-269AA (MBS)**





DIM.	Unit (mm)		Unit (	(inch)	
DIIVI.	Min.	Max.	Min.	Max.	
Α	-	2.90	-	0.114	
A1	-	0.20	-	0.008	
A2	2.30	2.70	0.091	0.106	
A3	0.95	1.53	0.037	0.060	
b	0.56	0.84	0.022	0.033	
С	0.15	0.35	0.006	0.014	
D	4.50	4.90	0.177	0.193	
E	-	6.90	-	0.272	
E1	3.60	5.00	0.142	0.197	
е	2.20	2.60	0.087	0.102	
L	0.70	1.10	0.028	0.043	
L1	1.10	2.12	0.043	0.083	

### **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	1.80	0.071
В	0.90	0.035
С	4.50	0.177
D	8.10	0.319
Е	1.30	0.051
F	6.30	0.248

### **MARKING DIAGRAM**



P/N = Marking Code YW = Date Code F = Factory Code



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